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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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Spec No.: DS22-2012-0212Effective Date: 09/26/2014

Revision: B

LITE-ON DCC

RELEASE

BNS-OD-FC001/A4

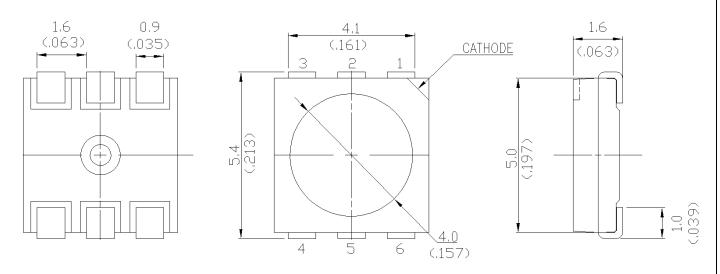


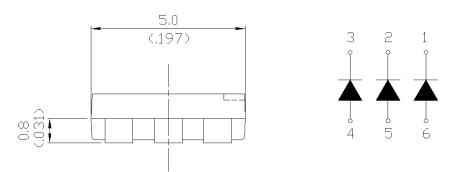
Property of Lite-On Only

Features

- * Meet ROHS, Green Product.
- * Package in 12mm tape on 7" diameter reels.
- * EIA STD package.
- * I.C. compatible.
- * Compatible with automatic placement equipment.
- * Compatible with infrared and reflow solder process.

Package Dimensions





Part No.	Lens Color	Source Color	Pin Assignment
		InGaN Blue	1,6
LTST-G563EGBW	Diffused Lens	InGaN Green	2,5
		AlInGaP Red	3,4

Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ± 0.2 mm (.008") unless otherwise noted.

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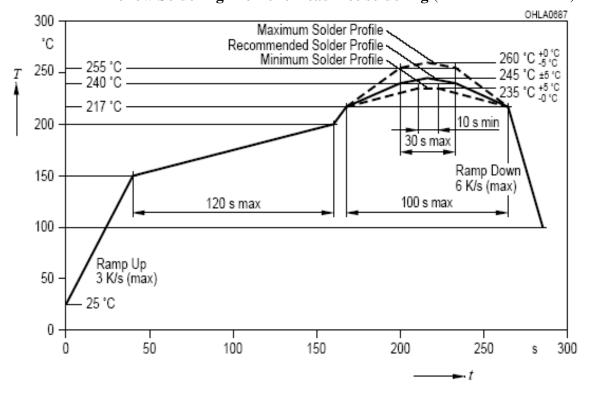
Property of Lite-On Only

Absolute Maximum Ratings at Ta=25℃

Parameter	LT	Unit		
1 arameter	Red	Green	Blue	Oint
Power Dissipation	130	114	114	mW
Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)	100	100	100	mA
DC Forward Current	50	30	30	mA
Operating Temperature Range	-40°C to +85°C			
Storage Temperature Range	-40°C to + 100°C			

Suggest IR Reflow Condition For Pb Free Process:

IR-Reflow Soldering Profile for lead free soldering (Acc. to J-STD-020B)



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Property of Lite-On Only

Electrical / Optical Characteristics at Ta=25°C

Parameter	Symbol	mbol LTST-G563EGBW			BW	Unit	Test	
1 drameter	Symbol		Red	Green	Blue	Oint	Condition	
		MIN.	560	1400	280			
Luminous Intensity	IV	TYP.	-	-	-	mcd	IF = 20mA Note 1	
		MAX.	1120	2800	560			
Viewing Angle	201/2	TYP.	120		deg	Note 2 (Fig.5)		
Peak Emission Wavelength	λΡ	TYP.	630	518	468	nm	Measurement @Peak (Fig.1)	
		MIN.	617	520	465			
Dominant Wavelength	λd	TYP.	-	-	-	nm	Note 3	
		MAX.	629	530	475			
Spectral Line Half-Width	Δλ	TYP.	25	35	20	nm		
		MIN.	1.8	2.8	2.8			
Forward Voltage	VF	TYP.	-	-	-	V	IF = 20mA Note. 4	
		MAX.	2.6	3.8	3.8			
Reverse Current	IR	MAX.	10	10	10	μΑ	VR = 5V Note 5	

NOTE: 1. Luminous intensity is measured with a light sensor and filter combination that approximates the CIE eye-response curve.

- 2. θ 1/2 is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
- 3. The dominant wavelength, λ d is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.
- 4. Forward Voltage Tolerance is +/- 0.1 volt.
- 5. Reverse voltage (VR) condition is applied to IR test only. The device is not designed for reverse operation.

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Property of Lite-On Only

Bin Code List

Luminous Intens	ity Color: Red, Un	nit: mcd @20mA
Bin Code	Min.	Max.
U2	560.0	710.0
V1	710.0	900.0
V2	900.0	1120.0

Tolerance on each Intensity bin is +/-11%

Luminous Intensi	ity Color: Green,	Unit : mcd @20mA
Bin Code	Min.	Max.
W2	1400.0	1800.0
X1	1800.0	2240.0
X2	2240.0	2800.0

Tolerance on each Intensity bin is +/-11%

Luminous Intensi	ty Color: <u>Blue</u> , U	nit : mcd @20mA
Bin Code	Min.	Max.
T1	280.0	355.0
T2	355.0	450.0
U1	450.0	560.0

Tolerance on each Intensity bin is +/-11%

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Property of Lite-On Only

Bin Code List

Dominant Waveleng	th Color: Green,	Unit: mcd @20mA
Bin Code	Min.	Max.
AP	520.0	525.0
AQ	525.0	530.0

Tolerance for each Dominate Wavelength bin is +/- 1nm

Dominant Wavelen	gth Color: Blue,	Unit : mcd @20mA
Bin Code	Min.	Max.
AC	465.0	470.0
AD	470.0	475.0

Tolerance for each Dominate Wavelength bin is +/- 1nm

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Property of Lite-On Only

Bin Code List

Luminous Intensity Unit : mcd @20mA										
Bin Code	R	ed	G	reen	В	lue				
On Tag	Code	Range	Code	Range	Code	Range				
A1					T1	280-355				
A2			W2	1400-1800	T2	355-450				
A3					U1	450-560				
A4					T1	280-355				
A5	U2	560-710	X1	1800-2240	T2	355-450				
A6						U1	450-560			
A7						T1	280-355			
A8							X2	2240-2800	T2	355-450
A9									U1	450-560
B1					T1	280-355				
B2			W2	1400-1800	T2	355-450				
В3					U1	450-560				
B4					T1	280-355				
В5	V1	710-900	X1	1800-2240	T2	355-450				
В6					U1	450-560				
В7					T1	280-355				
B8			X2	2240-2800	T2	355-450				
В9					U1	450-560				

Tolerance on each Intensity bin is +/-11%

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Property of Lite-On Only

Bin Code List

	Luminous Intensity Unit : mcd @20mA																		
Bin Code	R	ed	Gr	een	Bl	ue													
On Tag	Code	Range	Code	Range	Code	Range													
C1					T1	280-355													
C2		900-1120	900-1120		W2	1400-1800	T2	355-450											
C3							U1	450-560											
C4					900-1120	900-1120	900-1120	900-1120	900-1120	900-1120	900-1120			T1	280-355				
C5	V2											V2 900-1120	900-1120	900-1120	900-1120	X1	1800-2240	T2	355-450
C6															U1	450-560			
C7											T1	280-355							
C8			X2	2240-2800	T2	355-450													
C9					U1	450-560													

Tolerance on each Intensity bin is +/-11%

Dominant Wavelength Unit: nm @20mA										
Bin Code	Red		Gr	Green		Blue				
on Tag	Code	Range	Code	Range	Code	Range				
D1		617-629	AD	520-525	AC	465-470				
D2			617-629	617-629	617-629	617-629	AP	320-323	AD	470-475
D3	-						017-029	617-629	617-629	- 617-629
D4			AQ	525-530	AD	470-475				

Tolerance for each Dominate Wavelength Bin is +/- 1nm

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Property of Lite-On Only

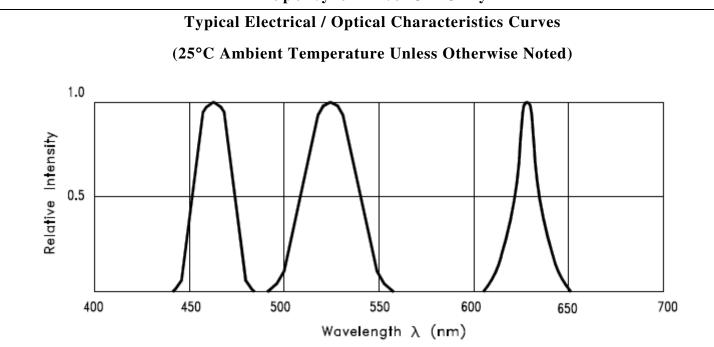


Fig.1 RELATIVE INTENSITY VS. WAVELENGTH

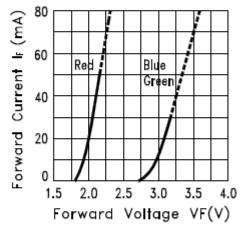


Fig.2 FORWARD CURRENT VS.
FORWARD VOLTAGE

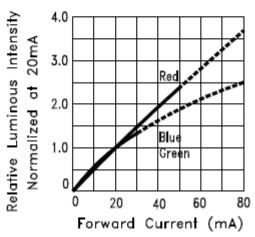


Fig.4 RELATIVE LUMINOUS INTENSITY VS. FORWARD CURRENT

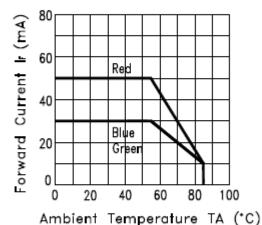


Fig.3 FORWARD CURRENT DERATING CURVE

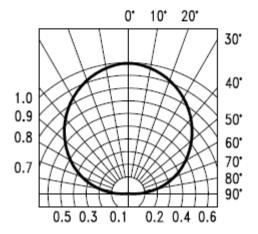


Fig.5 Spatial Distribution

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Property of Lite-On Only

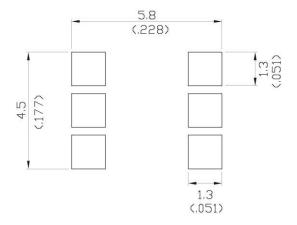
User Guide

Cleaning

Do not use unspecified chemical liquid to clean LED they could harm the package. If cleaning is necessary, immerse the LED in ethyl alcohol or isopropyl alcohol at normal temperature for less one minute.

Recommend Printed Circuit Board Attachment Pad

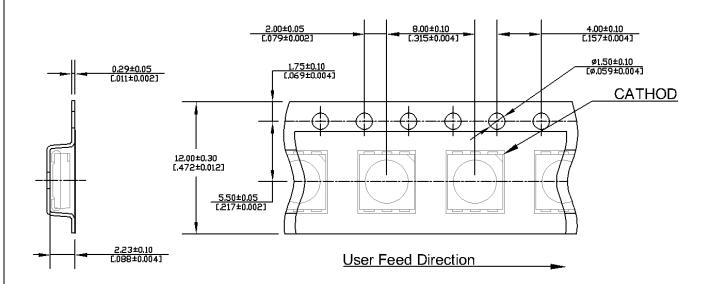
Infrared / vapor phase Reflow Soldering



Note:

1. All dimensions are in millimeters (inches).

Package Dimensions Of Tape And Reel



Note:

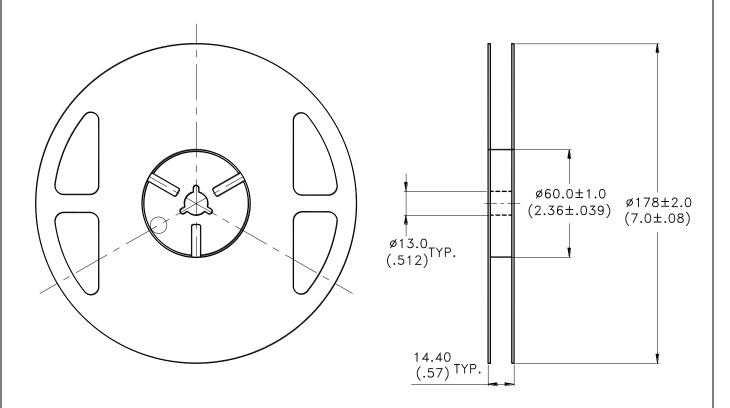
1. All dimensions are in millimeters (inches).

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Property of Lite-On Only

Package Dimensions of Reel



Notes:

- 1. Empty component pockets sealed with top cover tape.
- 2. 7 inch reel-1000 pieces per reel.
- 3. Minimum packing quantity is 500 pieces for remainders.
- 4. The maximum number of consecutive missing lamps is two.
- 5. In accordance with ANSI/EIA 481 specifications.

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Property of Lite-On Only

CAUTIONS

1. Application

The LEDs described here are intended to be used for ordinary electronic equipment (such as office equipment, communication equipment and household applications). Consult Liteon's Sales in advance for information on applications in which exceptional reliability is required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health (such as in aviation, transportation, traffic control equipment, medical and life support systems and safety devices).

2. Storage

The package is sealed:

The LEDs should be stored at 30°C or less and 70%RH or less. And the LEDs are limited to use within one year, while the LEDs is packed in moisture-proof package with the desiccants inside.

The package is opened:

The storage ambient for the LEDs should not exceed 30°C temperature and 60% relative humidity.

It is recommended that LEDs out of their original packaging are IR-reflowed within 168hrs.

For extended storage out of their original packaging, it is recommended that the LEDs be stored in a sealed container with appropriate desiccant, or in a desiccators with nitrogen ambient.

LEDs stored out of their original packaging for more than 168hrs should be baked at about 60 deg C for at least 48 hours before solder assembly.

3. Cleaning

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED if necessary.

4. Soldering

Recommended soldering conditions:

Reflow soldering		Soldering iron		
Pre-heat	150~200°C	Temperature	300°C Max.	
Pre-heat time	120 sec. Max.	Soldering time	3 sec. Max.	
Peak temperature	260°C Max.		(one time only)	
Soldering time	10 sec. Max.(Max. two times)			

Soldering notes:

Because different board designs use different number and types of devices, solder pastes, reflow ovens, and circuit boards, no single temperature profile works for all possible combinations.

However, you can successfully mount your packages to the PCB by following the proper guidelines and PCB-specific characterization.

LITE-ON Runs both component-level verification using in-house **KYRAMX98** reflow chambers and board-level assembly.

The results of this testing are verified through post-reflow reliability testing.

Profiles used at LITE-ON are based on JEDEC standards to ensure that all packages can be successfully and reliably surface mounted.

Figure on page3 shows a sample temperature profile compliant to JEDEC standards.

You can use this example as a generic target to set up your reflow process.

You should adhere to the JEDEC profile limits as well as specifications and recommendations from the solder paste manufacturer to avoid damaging the device and create a reliable solder joint.

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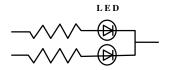
Property of Lite-On Only

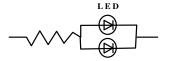
5. Drive Method

An LED is a current-operated device. In order to ensure intensity uniformity on multiple LEDs connected in parallel in an application, it is recommended that a current limiting resistor be incorporated in the drive circuit, in series with each LED as shown in Circuit A below.

Circuit model A

Circuit model B





- (A) Recommended circuit.
- (B) The brightness of each LED might appear different due to the differences in the I-V characteristics of those LEDs.

6. ESD (Electrostatic Discharge)

Static Electricity or power surge will damage the LED.

Suggestions to prevent ESD damage:

- Use of a conductive wrist band or anti-electrostatic glove when handling these LEDs.
- All devices, equipment, and machinery must be properly grounded.
- Work tables, storage racks, etc. should be properly grounded.
- Use ion blower to neutralize the static charge which might have built up on surface of the LED's plastic lens as a result of friction between LEDs during storage and handling.

ESD-damaged LEDs will exhibit abnormal characteristics such as high reverse leakage current, low forward voltage, or "no lightup" at low currents.

To verify for ESD damage, check for "lightup" and Vf of the suspect LEDs at low currents.

The Vf of "good " LEDs should be >2.0 V @ 0.1 mA for InGaN product and >1.4 V @ 0.1 mA for AlInGaP product.

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Property of Lite-On Only

7. Reliability Test

No.	Test item	Test condition	Reference standard
1	Resistance to soldering heat	Tsld = 260°C, 10sec. 3 times	JEITA ED-4701 300 301
2	Solderability	Tsld=245± 5°C (Lead Free Solder, Coverage ≥ 95% of the dipped surface)	JEITA ED-4701 300 303
3	Thermal Shock	85 ± 5°C ~ -30°C ± 5°C 30min 30min 100cycles	JEITA ED-4701 300 307
4	Temperature Cycle	-55°C ~ 25°C ~ 100°C ~ 25°C 30min 5min 30min 5min 100cycles	JEITA ED-4701 100 105
5	High Temperature Storage	100°C 1000hrs	JEITA ED-4701 200 201
6	Low Temperature Storage	-55°C 1000hrs	JEITA ED-4701 200 202
7	Temperature Humidity Storage	60°C/90%RH 300hrs	JEITA ED-4701 100 103
8	Room temp life test	25°C, IF: Max current, 1000hrs	

8. Others

The appearance and specifications of the product may be modified for improvement without prior notice.

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Property of Lite-On Only

9. Suggested Checking List

Training and Certification

- 1. Everyone working in a static-safe area is ESD-certified?
- 2. Training records kept and re-certification dates monitored?

Static-Safe Workstation & Work Areas

- 1. Static-safe workstation or work-areas have ESD signs?
- 2. All surfaces and objects at all static-safe workstation and within 1 ft measure less than 100V?
- 3. All ionizer activated, positioned towards the units?
- 4. Each work surface mats grounding is good?

Personnel Grounding

- 1. Every person (including visitors) handling ESD sensitive (ESDS) items wears wrist strap, heel strap or conductive shoes with conductive flooring?
- 2. If conductive footwear used, conductive flooring also present where operator stand or walk?
- 3. Garments, hairs or anything closer than 1 ft to ESD items measure less than 100V*?
- 4. Every wrist strap or heel strap/conductive shoes checked daily and result recorded for all DLs?
- 5. All wrist strap or heel strap checkers calibration up to date? Note: *50V for Blue LED.

Device Handling

- 1. Every ESDS items identified by EIA-471 labels on item or packaging?
- 2. All ESDS items completely inside properly closed static-shielding containers when not at static-safe workstation?
- 3. No static charge generators (e.g. plastics) inside shielding containers with ESDS items?
- 4. All flexible conductive and dissipative package materials inspected before reuse or recycles?

Others

- 1. Audit result reported to entity ESD control coordinator?
- 2. Corrective action from previous audits completed?
- 3. Are audit records complete and on file?

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